

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	1025368
<b>Application Number:</b>	09379702
<b>Confirmation Number:</b>	1613
<b>Title of Invention:</b>	METHOD OF FABRICATING SEMICONDUCTOR DEVICES
<b>First Named Inventor:</b>	HISASHI OHTANI
<b>Customer Number:</b>	20985
<b>Filer:</b>	John F. Hayden/Paul Stovenour
<b>Filer Authorized By:</b>	John F. Hayden
<b>Attorney Docket Number:</b>	07977/093002
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### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Supplemental Appeal Brief	07977093002Brief.pdf	4920151	no	11

<b>Warnings:</b>	
<b>Information:</b>	
<b>Total Files Size (in bytes):</b>	4920151
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<p><b>New Applications Under 35 U.S.C. 111</b> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p>	
<p><b>National Stage of an International Application under 35 U.S.C. 371</b> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>	